

40-81000-310C

equest a Quote

40-81000-310C Information

Heisener.com	Part Number	40-81000-310C
	Manufacturer	Aries Electronics
	Category	Connectors, Interconnects Sockets for ICs, Transistors
	Description	CONN IC DIP SOCKET 40POS GOLD
	Package	-
		For the pricing/inventory/lead time, please contact
For Reference Only		us
		Website: https://www.heisener.com E-mail: salesdept@heisener.com

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



40-81000-310C Specifications

Manufacturer Part Number40-8100-310CManufacturerAries ElectronicsCategoryConnectors, InterconnectsSockets for ICs, TransistorsPackage-Series8TypeDIP, 0.3" (7.62mm) Row SpacingNumber of Positions or Pins (Grid)40 (2 x 20)Pitch - MatingGoldContact Finish - MatingGoldContact Finish Thickness - MatingSolderMouning TypeThrough HoleFeaturesClosed Frame, ElevatedPitch - PostGoldContact Finish - PostGoldContact Finish - PostGoldContact Finish Thickness - SpaceSolderFeaturesGoldContact Finish - PostGoldContact Finish - PostGoldContact Finish - PostGoldContact Finish - PostBarssContact Material - NatingBarssContact Material - PostBrass		
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Contact Finish - PostGoldContact Finish Thickness - Post10µin (0.25µm)Contact Material - PostBrass	Termination	Solder
Contact Finish Thickness - Post10µin (0.25µm)Contact Material - PostBrass	Pitch - Post	0.100" (2.54mm)
Contact Material - Post Brass	Contact Finish - Post	Gold
	Contact Finish Thickness - Post	10µin (0.25µm)
Housing Material Polyamida (PA46) Nylon 4/6 Class Filled	Contact Material - Post	Brass
Folyamide (FA40), Nyion 4/0, Olass Fined	Housing Material	Polyamide (PA46), Nylon 4/6, Glass Filled
Operating Temperature $-55^{\circ}C \sim 105^{\circ}C$	Operating Temperature	-55°C ~ 105°C
Report error		Report errors?

40-81000-310C Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

40-81000-310C Payment Methods





If you have any question about 40-81000-310C, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com